Disclosure No. 01-0327.01

**PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

LENG NAM YIN AND

LIM THIAM CHYE

FILED:

**CONCURRENTLY HEREWITH** 

For:

WIRE BONDED MICROELECTRONIC

**DEVICE ASSEMBLIES AND METHODS** 

OF MANUFACTURING SAME

## **Preliminary Amendment**

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Commissioner:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2.

Amendments to the Claims are reflected in the listing of claims beginning on page 3.